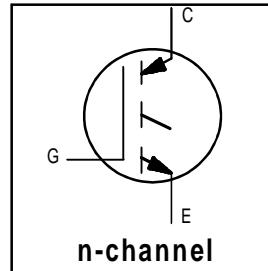


IRG4PH50K

Short Circuit Rated
UltraFast IGBT

Features

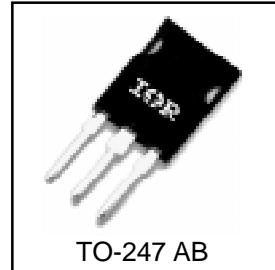
- High short circuit rating optimized for motor control, $t_{sc} = 10\mu s$, $V_{CC} = 720V$, $T_J = 125^\circ C$, $V_{GE} = 15V$
- Combines low conduction losses with high switching speed
- Latest generation design provides tighter parameter distribution and higher efficiency than previous generations



$V_{CES} = 1200V$
$V_{CE(on)} \text{ typ.} = 2.77V$
$@V_{GE} = 15V, I_C = 24A$

Benefits

- As a Freewheeling Diode we recommend our HEXFRED™ ultrafast, ultrasoft recovery diodes for minimum EMI/Noise and switching losses in the Diode and IGBT
- Latest generation 4 IGBTs offer highest power density motor controls possible
- This part replaces the IRGPH50K and IRGPH50M devices



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Voltage	1200	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	45	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	24	
I_{CM}	Pulsed Collector Current ①	90	
I_{LM}	Clamped Inductive Load Current ②	90	
t_{sc}	Short Circuit Withstand Time	10	μs
V_{GE}	Gate-to-Emitter Voltage	± 20	V
E_{ARV}	Reverse Voltage Avalanche Energy ③	190	mJ
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	200	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	78	
T_J	Operating Junction and Storage Temperature Range	-55 to +150	$^\circ C$
T_{STG}	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf·in (1.1N·m)	

Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	0.64	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.24	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	40	
Wt	Weight	6 (0.21)	—	g (oz)

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage	1200	—	—	V	$V_{\text{GE}} = 0\text{V}$, $I_C = 250\mu\text{A}$
$V_{(\text{BR})\text{ECS}}$	Emitter-to-Collector Breakdown Voltage	18	—	—	V	$V_{\text{GE}} = 0\text{V}$, $I_C = 1.0\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.91	—	V/ $^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}$, $I_C = 2.0\text{mA}$
$V_{\text{CE}(\text{ON})}$	Collector-to-Emitter Saturation Voltage	—	2.77	3.5	V	$I_C = 24\text{A}$ $V_{\text{GE}} = 15\text{V}$
		—	3.28	—		$I_C = 45\text{A}$ see figures 2, 5
		—	2.54	—		$I_C = 24\text{A}$, $T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-10	—	mV/ $^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 2.0\text{mA}$
g_{fe}	Forward Transconductance	13	19	—	S	$V_{\text{CE}} = 100\text{ V}$, $I_C = 24\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	250	μA	$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 1200\text{V}$
		—	—	2.0		$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 10\text{V}$, $T_J = 25^\circ\text{C}$
		—	—	5000		$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 1200\text{V}$, $T_J = 150^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{\text{GE}} = \pm 20\text{V}$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions	
Q_g	Total Gate Charge (turn-on)	—	180	270	nC	$I_C = 24\text{A}$	
Q_{ge}	Gate - Emitter Charge (turn-on)	—	25	38		$V_{\text{CC}} = 400\text{V}$ see figure 8	
Q_{gc}	Gate - Collector Charge (turn-on)	—	70	110		$V_{\text{GE}} = 15\text{V}$	
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	36	—	ns	$T_J = 25^\circ\text{C}$ $I_C = 24\text{A}$, $V_{\text{CC}} = 960\text{V}$ $V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$ Energy losses include "tail" see figures 9,10,14	
t_r	Rise Time	—	27	—			
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	200	300			
t_f	Fall Time	—	130	190			
E_{on}	Turn-On Switching Loss	—	1.21	—	mJ		
E_{off}	Turn-Off Switching Loss	—	2.25	—			
E_{ts}	Total Switching Loss	—	3.46	4.1			
t_{sc}	Short Circuit Withstand Time	10	—	—	μs	$V_{\text{CC}} = 720\text{V}$, $T_J = 125^\circ\text{C}$ $V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$	
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	35	—	ns	$T_J = 150^\circ\text{C}$, $I_C = 24\text{A}$, $V_{\text{CC}} = 960\text{V}$ $V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$ Energy losses include "tail" see figures 10,11,14	
t_r	Rise Time	—	29	—			
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	380	—			
t_f	Fall Time	—	280	—			
E_{ts}	Total Switching Loss	—	7.80	—	mJ		
L_E	Internal Emitter Inductance	—	13	—	nH		
C_{ies}	Input Capacitance	—	2800	—	pF		
C_{oes}	Output Capacitance	—	140	—			
C_{res}	Reverse Transfer Capacitance	—	53	—	$V_{\text{GE}} = 0\text{V}$ $V_{\text{CC}} = 30\text{V}$ see figure 7 $f = 1.0\text{MHz}$		

Notes:

- ① Repetitive rating; $V_{\text{GE}} = 20\text{V}$, pulse width limited by maximum junction temperature. (see figure 13b)
- ② $V_{\text{CC}} = 80\%$ (V_{CES}), $V_{\text{GE}} = 20\text{V}$, $L = 10\mu\text{H}$, $R_G = 5.0\Omega$, (see figure 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width $\leq 80\mu\text{s}$; duty factor $\leq 0.1\%$.
- ⑤ Pulse width $5.0\mu\text{s}$, single shot.

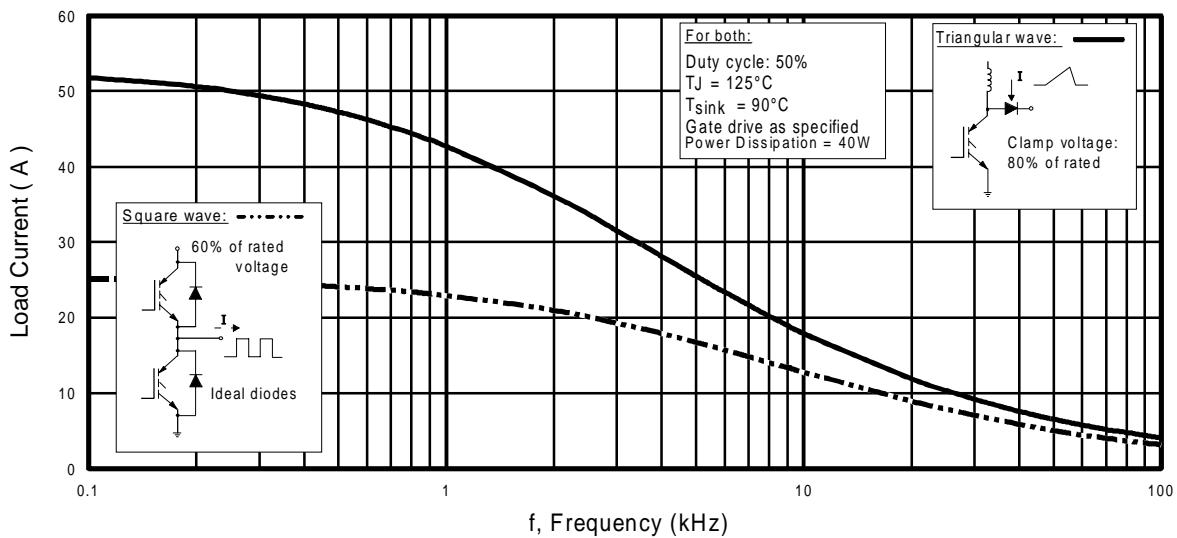


Fig. 1 - Typical Load Current vs. Frequency
(Load Current = I_{RMS} of fundamental)

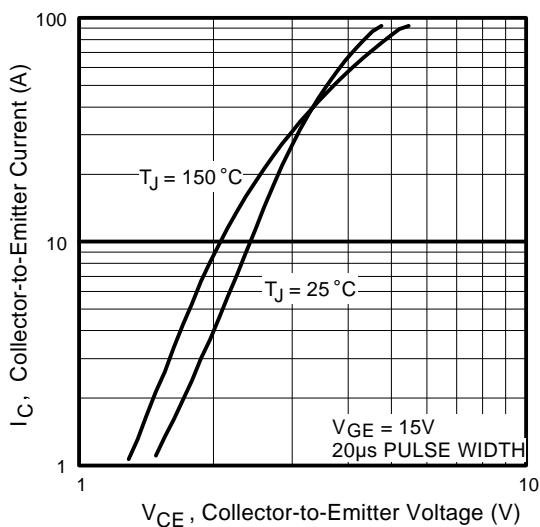


Fig. 2 - Typical Output Characteristics

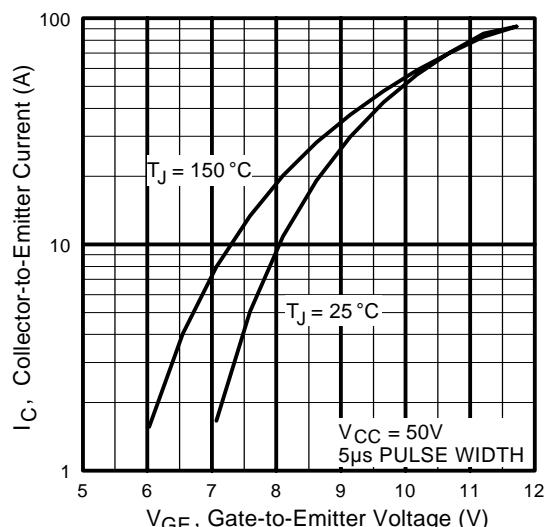


Fig. 3 - Typical Transfer Characteristics

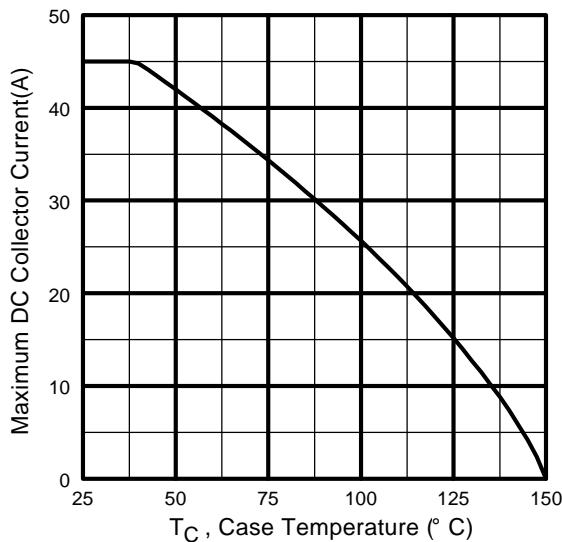


Fig. 4 - Maximum Collector Current vs. Case Temperature

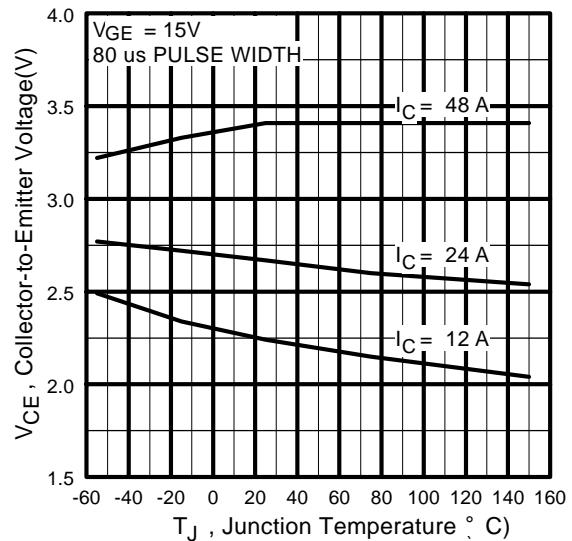


Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature

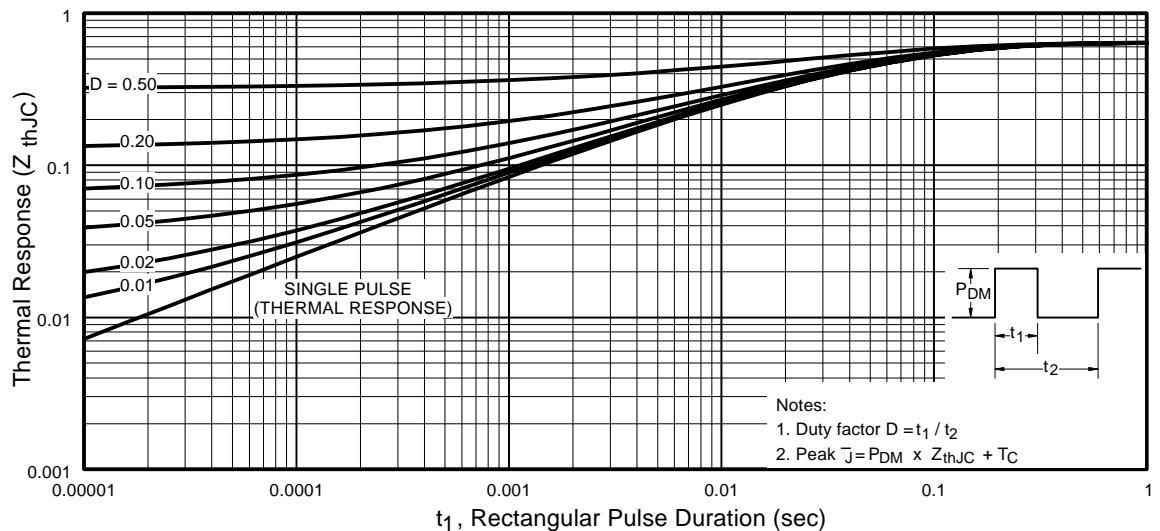
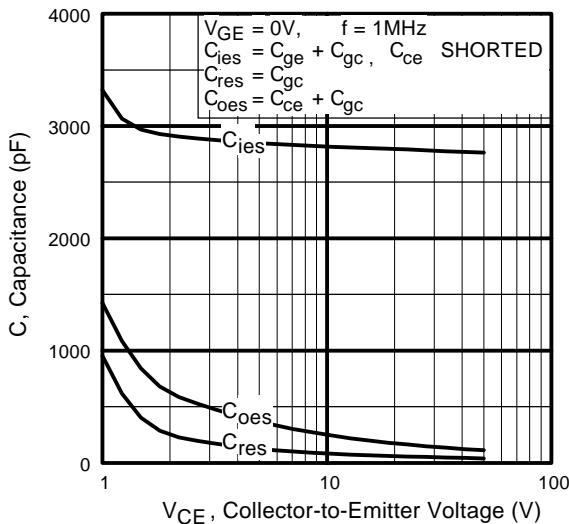
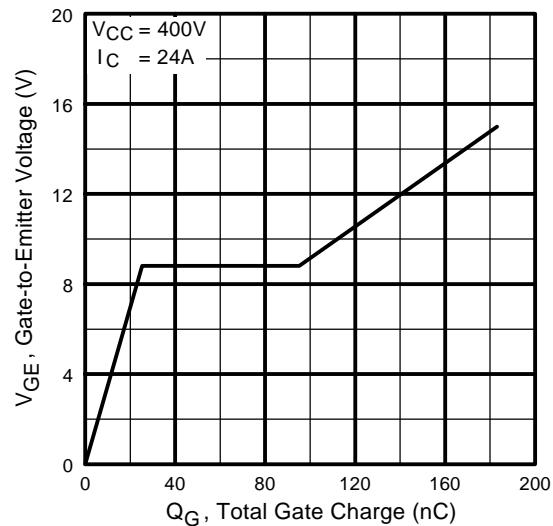


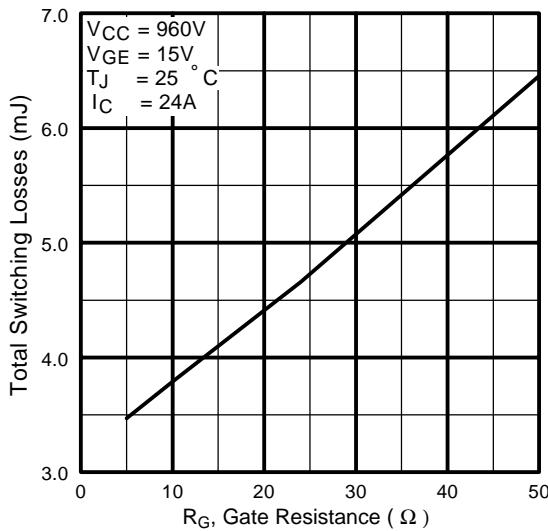
Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



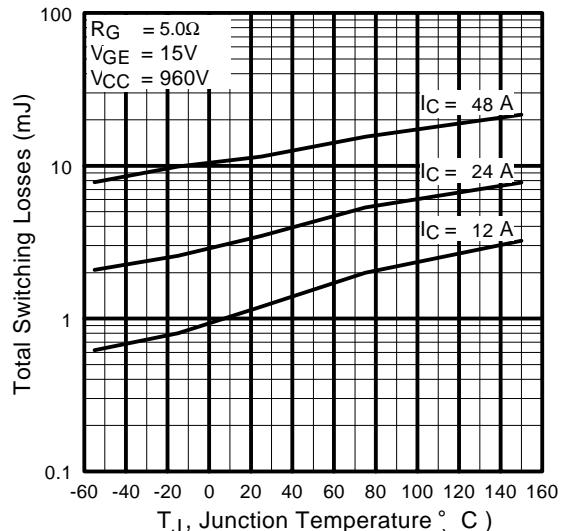
**Fig. 7 - Typical Capacitance vs.
Collector-to-Emitter Voltage**



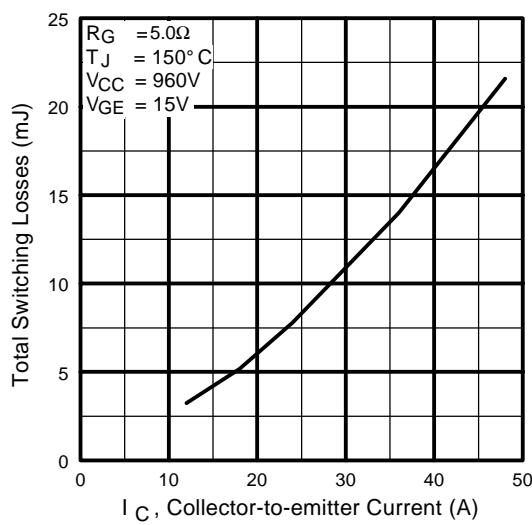
**Fig. 8 - Typical Gate Charge vs.
Gate-to-Emitter Voltage**



**Fig. 9 - Typical Switching Losses vs.
Gate Resistance**



**Fig. 10 - Typical Switching Losses vs.
Junction Temperature**



**Fig. 11 - Typical Switching Losses vs.
Collector-to-Emitter Current**

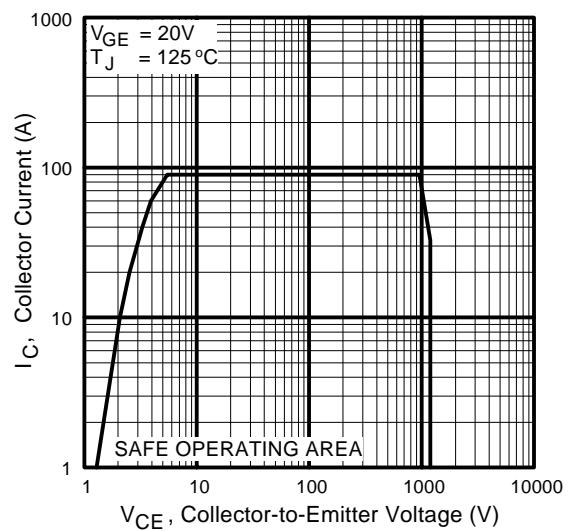


Fig. 12 - Turn-Off SOA